

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of : Customer Number: 89518  
Lin, Mou-Shiung : Confirmation Number: 8665  
Application No.: 10/755,042 : Group Art Unit: 2815  
Filed: January 9, 2004 : Examiner: Jackson, Jr., Jerome  
For: INTEGRATED CHIP PACKAGE STRUCTURE USING SILICON SUBSTRATE AND  
METHOD OF MANUFACTURING THE SAME

Mail Stop RCE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**CERTIFICATE OF ELECTRONIC TRANSMISSION**  
I hereby certify that this correspondence is being electronically-  
transmitted to the United States Patent and Trademark Office on June  
24, 2010.  
/Tobi A. Herbert/  
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Tobi A. Herbert

**AMENDMENT**

Sir:

It is respectfully requested that the time for response to the final Office Action dated February 24, 2010 be extended for one month to June 24, 2010. Please charge the extension fee of \$130.00 to Deposit Account No. 502624. Please charge any additional fees or credit any overpayment to Deposit Account No. 502624.

In response to the final Office Action dated February 24, 2010, a Request for Continued Examination being filed herewith, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 9 of this paper.

An **Appendix** is attached after the last page, which shows the status of related cases.